PATENT ASSIGNMENT COVER SHEET

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CONVEYING PARTY DA	ΤΑ			
	Name	Execution Date		
		05/40/0000		
Yasuhiro Koike		05/16/2022		
		05/16/2022		
RECEIVING PARTY DAT	Γ Α	05/16/2022		
RECEIVING PARTY DAT	TA NITTO DENKO CORPORATION	05/16/2022		

City:	IBARAKI-SHI, OSAKA
State/Country:	JAPAN
Postal Code:	567-8680

Property Type	Number	
Patent Number:	8945669	
CORRESPONDENCE DAT	Α	
Fax Number:	(202)530-1281	
	ent to the e-mail address first; if that is unsuccessful, it will vided; if that is unsuccessful, it will be sent via US Mail.	be sent
Phone:	2025301280	
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Correspondent Name:	LEE CHENG	
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Address Line 4:	WASHINGTON, D.C. 20005	
TTORNEY DOCKET NUME	BER: KSM-5002	
ATTOMILET BOOKET NOME		
	LEE CHENG	
NAME OF SUBMITTER: SIGNATURE:	/Lee Cheng/	

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RESUBMIT DOCUMENT ID:): 507411409	
CONVEYING PA	RTY DATA		
		Name	Execution Date
Yasuhiro Koike			05/16/2022
Street Address:	1-2, Shimohozumi 1-chome		
Name:	NITTO DENKO CORPORATION		
Street Address:	1-2, Shimohozumi 1-chome		
City:	l baraki shi , Osaka		
State/Country:	Ibaraki-shi, Osaka Japan letter "l" should read capital letter "I" in "Ibaraki-shi" 567-8680		
Postal Code:	567-8680		
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ROPERTY NUN Property ' Patent Number:		·	lumber

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REEL: 061372 FRAME: 0104

Email:patent@chenglawgroup.comCorrespondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.Correspondent Name:LEE CHENGAddress Line 1:1133 13TH STREET N.W. STE C2Address Line 4:WASHINGTON, D.C. 20005				
ATTORNEY DOCKET NUMBER:	KSM-5002			
NAME OF SUBMITTER:	LEE CHENG			
Signature:	/Lee Cheng/			
Date:	09/01/2022			
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ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the assignee **Yasuhiro KOIKE** (the undersigned Assignor), does hereby assign, sell and transfer unto:

NITTO DENKO CORPORATION, of the address

1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka 567-8680, JAPAN

(hereinafter ASSIGNEE), its successors, assigns, and legal representatives, 100% of its right, title and interest for the United States, and countries foreign thereto, in and to the inventions relating to

U.S. Patent No. 8,945,669 Entitled: EXTRUSION MATERIAL SUPPLY DEVICE AND OPTICAL TRANSMISSION BODY MANUFACTURING METHOD USING THE SAME (assignments recorded at Reel 026942, Frame 0274 and Reel 042770, Frame 0268)

and in and to said patents and patent applications, including any divisions and continuations thereof, and in and to any and all Letters Patents of the United States, and countries foreign thereto, which may be granted for said inventions, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patents

And, the undersigned warrants and covenants that it is an assignee of these patents and patent applications and has the full and unencumbered right to sell and assign 100% of its interests herein and that it has not executed and will not execute any document or instrument in conflict herewith;

And, the undersigned further covenants and agrees that at any time upon request of said ASSIGNEE, its successors, legal representatives or assigns he will communicate to said ASSIGNEE, its successors, legal representatives or assigns all information known to him relating to said inventions or patent applications and that he will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings and perform all other lawful acts deemed necessary or desirable by said ASSIGNEE, its successors, legal representatives or assigns to perfect title to said inventions, to said applications including divisions and continuations thereof and to any and all Letters Patent which may be granted therefor or thereon, including reissues or extensions, in said ASSIGNEE, its successors, or assigns or to assist said ASSIGNEE, its successors, legal representatives or assigns in obtaining, reissuing or enforcing Letters Patent of the United States for said invention.

And, the undersigned hereby acknowledges that ASSIGNEE will possess 100% ownership interest in the invention set forth above upon the execution of this Assignment.

ASSIGNOR

Yasahiro KOIKE

12-22, 3-chome, Azaminominami, Aoba-ku Yokohama-shi, Kanagawa 225-0012, JAPAN

By: <u>Jasuhiro Korko Date: May 16, 2022</u> Vasuhiro KOIKE

ASSIGNEE

NITTO DENKO CORPORATION 1-2, Shimohozumi 1-chome Ibaraki-shi, Osaka 567-8680, JAPAN

By: Thoto Date: July 22, 2022 Hironori MOTOMURA

Director Technology and IP Strategy Division Corporate Technology Sector

> PATENT REEL: 061372 FRAME: 0107

RECORDED: 09/09/2022